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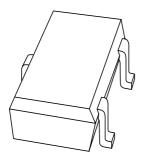
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



2PB1219APNP general purpose transistor

Product data sheet Supersedes data of 1997 Mar 25 1999 Apr 12



PNP general purpose transistor

2PB1219A

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 50 V)
- Low collector-emitter saturation voltage (max. 600 mV).

APPLICATIONS

• General purpose switching and amplification.

DESCRIPTION

PNP transistor in a SOT323; SC70 plastic package. NPN complement: 2PD1820A.

MARKING

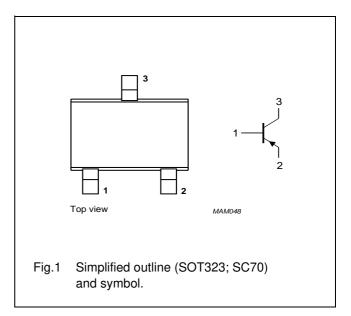
| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| 2PB1219AQ | D*Q |
| 2PB1219AR | D*R |
| 2PB1219AS | D*S |

Note

* = - : Made in Hong Kong.
 * = t : Made in Malaysia.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | -60 | ٧ |
| V_{CEO} | collector-emitter voltage | open base | _ | -50 | ٧ |
| V_{EBO} | emitter-base voltage | open collector | _ | -5 | ٧ |
| I _C | collector current (DC) | | - | -500 | mA |
| I _{CM} | peak collector current | | _ | -1 | Α |
| I _{BM} | peak base current | | _ | -200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | _ | 200 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

1. Refer to SOT323; SC70 standard mounting conditions.

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|---------------------------------------------|------------|-------|------|
| R _{th j-a} | thermal resistance from junction to ambient | note 1 | 625 | K/W |

Note

1. Refer to SOT323; SC70 standard mounting conditions.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------------|--------------------------------------|-----------------------------------------------------------------|------|------|------|
| I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = -20 V | _ | -100 | nA |
| | | $I_E = 0; V_{CB} = -20 \text{ V}; T_j = 150 \text{ °C}$ | _ | -5 | μА |
| I _{EBO} | emitter cut-off current | $I_C = 0; V_{EB} = -4 V$ | _ | -100 | nA |
| h _{FE} | DC current gain | $I_C = -150 \text{ mA}; V_{CE} = -10 \text{ V}; \text{ note 1}$ | | | |
| | 2PB1219AQ | | 85 | 170 | |
| | 2PB1219AR | | 120 | 240 | |
| | 2PB1219AS | | 170 | 340 | |
| h _{FE} | DC current gain | $I_C = -500 \text{ mA}$; $V_{CE} = -10 \text{ V}$; note 1 | 40 | _ | |
| V _{CEsat} | collector-emitter saturation voltage | $I_C = -300 \text{ mA}$; $I_B = -30 \text{ mA}$; note 1 | _ | -600 | mV |
| V _{BEsat} | base-emitter saturation voltage | IC = -300 mA; IB = -30 mA; note 1 | _ | -1.5 | V |
| C _c | collector capacitance | $I_E = i_e = 0; V_{CB} = -10 \text{ V}; f = 1 \text{ MHz}$ | _ | 15 | pF |
| f _T | transition frequency | $I_C = 50 \text{ mA}; V_{CE} = -10 \text{ V};$ | | | |
| | 2PB1219AQ | f = 100 MHz; note 1 | 100 | _ | MHz |
| | 2PB1219AR | | 120 | _ | MHz |
| | 2PB1219AS | | 140 | _ | MHz |

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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PNP general purpose transistor

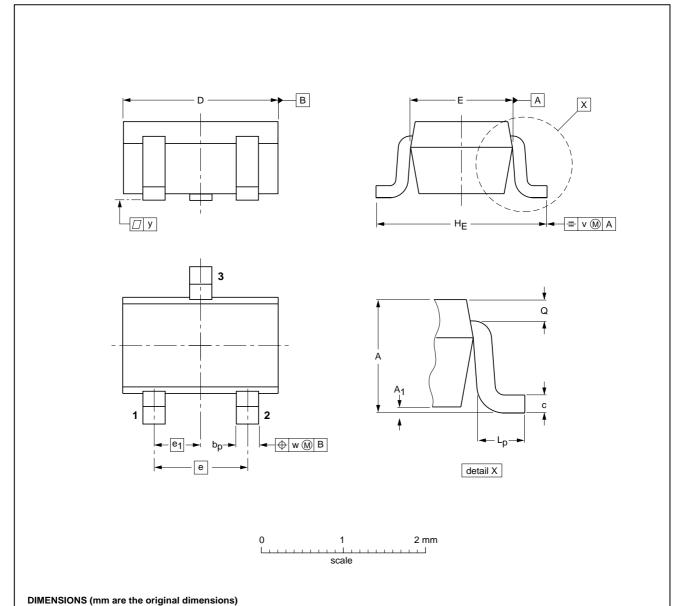
2PB1219A

PACKAGE OUTLINE

UNIT

Plastic surface mounted package; 3 leads

SOT323



| OUTLINE | OUTLINE REFERENCES | | | EUROPEAN | ISSUE DATE | |
|---------|--------------------|-------|-------|----------|------------|------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE |
| SOT323 | | | SC-70 | | | 97-02-28 |

e₁

0.65

ΗE

Lp

0.45

Q

0.2

Ε

1.3

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bp

0.25

0.10

max

PNP general purpose transistor

2PB1219A

DATA SHEET STATUS

| DOCUMENT STATUS(1) | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|------------------------|----------------------------------|---------------------------------------------------------------------------------------|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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1999 Apr 12

NXP Semiconductors

Customer notification

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Contact information

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